mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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XL-25 **Ceramic Heat Spreader**





Features

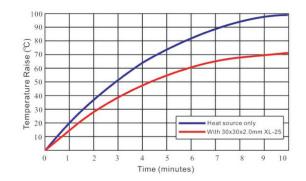
Large contact area Low weight High breakdown voltage Excellent heat spreader Custom shapes possible

Applications

LED / Notebook PC / M/B / Power Transistor / Power Module / CPU / Chip IC

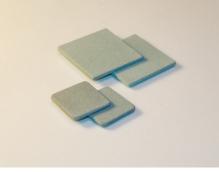
Standard sizes (mm)

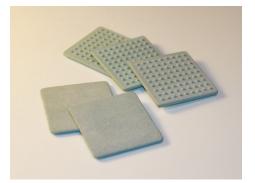
| 1. | 10 x 10 x 2.0 |
|----|---------------|
| 2. | 20 x 20 x 2.0 |
| 3. | 30 x 30 x 2.0 |
| 4. | 40 x 40 x 2.0 |
| 5. | 40 x 40 x 3.0 |
| 6. | 40 x 40 x 3.0 |
| 7. | 50 x 50 x 3.0 |



Used examples: Heat sources with XL-25







| Property | XL-25 | Unit | Test Method |
|--|---|---------------------|----------------|
| Colour | Green | - | Visual |
| Thermal Conductivity | 6.79 | W/mK | - |
| Dielectric Breakdown Voltage | >500 | Voltage | ASTM D149 |
| Specific Gravity | 1.89 | g/cm³ | CNS 619 |
| Surface Resistance | >10 ⁹ | Ohm | ASTMD 257 |
| Flexural Strength | 47.5 | Kgf/cm ² | CNS 12701 |
| Porosity | 30 | % | CNS 619 |
| Working Temperature | >500 | °C | - |
| Linear Temperature Expansion Coefficient | 4.13 | 10/06/11 | RT~300 °C |
| Main Composition | SiC / Al ₂ O ₃ / SiO ₂ | - | - |
| Hardness | 5 - 6 | Moh's | DIN EN101-1992 |